(Following Paper ID and Roll No. to be filled in your Answer Books) Paper ID: 2012358 Roll No.

B.TECH.

Regular Theory Examination (Odd Sem-VII), 2016-17

VLSI DESIGN

Time: 3 Hours

Max. Marks: 100

SECTION-A

- 1 Attempt all questions. All parts carry equal marks. Write answer of each part in short. $(10\times2=20)$
 - a) What do you meant by threshold voltage of MOS transistor? Explain
 - b) List the steps used for CMOS fabrication.
 - c) Define delay time and discuss delay models.
 - d) Name any two basic CAD tools and explain.
 - e) Describe basic principle of pass transistor circuits.
 - f) Write the importance low power in VLSI architectures.
 - g) Bring out the drawbacks of dynamic logic.
 - h) Distinguish between SRAM and DRAM.
 - i) Classify adiabatic logic circuits.

j) Mention the scaling principles. What is the need for scaling.

SECTION-B

Note: Attempt any five questions from this section. $(5\times10=50)$

- 2. Analyze the characteristics of CMOS inverter with neat sketch.
- 3. What do you mean by Design for testability. Discuss scan based techniques.
- 4. Narrate in detail about VLSI low power architectures with suitable diagram.
- 5. Design an 8MB X 16 bit memory architecture using 512K X 8 bit memory chip.
- **6.** Explain the Ad Hoc testable design techniques with a suitable example.
- 7. Illuminate the n-well CMOS fabrication process with neat diagrams.
- 8. Analyze the different gate delay model of CMOS gate transistor.
- 9. Differentiate between EEPROM and Flash memory.

SECTION-C

Note: Attempt any two questions from this section. $(2\times15=30)$

- **10.** Implement a 2 input NAND gate using:
 - a) Dynamic CMOS logic

- b) Domino CMOS logic
- 11. Derive the expression for total power dissipation of a CMOS circuit.
- 12. Narrate in detail about the operation of NMOS transistor with different operating modes.